TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

# **MT6L58AT**

VHF~UHF BAND LOW NOISE AMPLIFIER APPLICATIONS

• Two devices are built in to the super-thin and ultra super mini (6 pins) package: TU6

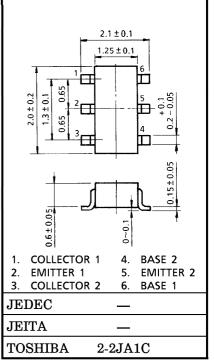
#### **MOUNTED DEVICES**

	Q1 : SSM (TESM)	Q2 : SSM (TESM)
Three-pins (SSM/TESM) mold	MT3S06S	MT3S03AS
products are corresponded.	(MT3S06T)	(MT3S03AT)

## MAXIMUM RATINGS (Ta = 25°C)

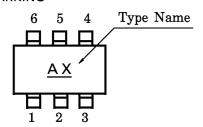
CHARACTERISTIC	SYMBOL	Q1	Q2	UNIT
Collector-Base Voltage	$v_{\mathrm{CBO}}$	10	10	V
Collector-Emitter Voltage	$v_{CEO}$	5	5	V
Emitter-Base Voltage	$v_{ m EBO}$	1.5	2	V
Collector Current	$I_{\mathbf{C}}$	15	40	mA
Base Current	$I_{\mathbf{B}}$	7	10	mA
Collector Power Dissipation	PC	150		mW
Junction Temperature	$T_{\mathrm{j}}$	125		°C
Storage Temperature Range	$ m T_{stg}$	-55~125		°C

#### Unit in mm

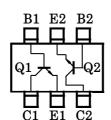


Weight: 0.008 g

## **MARKING**



## PIN ASSIGNMENT (TOP VIEW)



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## ELECTRICAL CHARACTERISTICS Q1 (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	$I_{ m CBO}$	$V_{CB} = 5 \text{ V}, I_{E} = 0$	_	_	0.1	$\mu$ A
Emitter Cut-off Current	${ m I}_{ m EBO}$	$V_{EB} = 1 V, I_C = 0$	_	_	1	$\mu$ A
DC Current Gain	${ m h_{FE}}$	$V_{CE} = 1 V$ , $I_{C} = 5 mA$	70	_	140	_
Transition Frequency	${ m f_T}$	$ m V_{CE} = 3  V,  I_{C} = 5  mA$	7	10	_	GHz
Insertion Gain	$ S_{21e} ^2$ (1)	$egin{aligned} \mathrm{V_{CE}} &= 1  \mathrm{V, \ I_{C}} = 5  \mathrm{mA,} \\ \mathrm{f} &= 2  \mathrm{GHz} \end{aligned}$	_	7.5	_	dB
	$ S_{21e} ^2$ (2)	$egin{aligned} \mathrm{V_{CE}} &= 3  \mathrm{V, \ I_{C}} = 7  \mathrm{mA,} \\ \mathrm{f} &= 2  \mathrm{GHz} \end{aligned}$	4.5	8	_	dB
Noise Figure —	NF (1)	$V_{\mathrm{CE}} = 1  \mathrm{V},  \mathrm{I}_{\mathrm{C}} = 3  \mathrm{mA},$ $\mathrm{f} = 2  \mathrm{GHz}$	_	1.7	3	dB
	NF (2)	$egin{aligned} \mathrm{V_{CE}} = 3  \mathrm{V, \ I_{C}} = 3  \mathrm{mA,} \\ \mathrm{f} = 2  \mathrm{GHz} \end{aligned}$	_	1.6	3	dB
Reverse Transfer Capacitance	$\mathrm{C_{re}}$	$egin{aligned} V_{\mathrm{CB}} &= 1  \mathrm{V},  \mathrm{I_E} = 0, \\ \mathrm{f} &= 1  \mathrm{MHz}   \mathrm{(Note)} \end{aligned}$	_	0.35	0.75	pF

## ELECTRICAL CHARACTERISTICS Q2 (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	$I_{\mathrm{CBO}}$	$V_{CB} = 5 \text{ V}, I_{E} = 0$	_	_	0.1	$\mu$ A
Emitter Cut-off Current	${ m I}_{ m EBO}$	$V_{EB} = 1 V, I_{C} = 0$	_	_	1	$\mu$ A
DC Current Gain	${ m h_{FE}}$	$V_{CE} = 1 V$ , $I_{C} = 5 mA$	80	_	160	_
l'Iransition Ereguency ——	f <sub>T</sub> (1)	$ m V_{CE} = 1~V,~I_{C} = 5~mA$	5	7	_	GHz
	f <sub>T</sub> (2)	$ m V_{CE} = 3~V,~I_{C} = 10~mA$	7	10	_	GHz
Incortion (-ain	$ S_{21e} ^2$ (1)	$ m V_{CE}=1~V,~I_{C}=5~mA,~f=2~GHz$	_	5	_	dB
	$ S_{21e} ^2$ (2)	$V_{CE} = 3 V, I_{C} = 20 \text{ mA}, f = 2 \text{ GHz}$	3	6.5	_	dB
I Noise Kigure	NF (1)	$V_{CE} = 1 \text{ V}, I_{C} = 5 \text{ mA}, f = 2 \text{ GHz}$	_	1.7	3	dB
	NF (2)	$V_{ m CE}=3~{ m V},~{ m I}_{ m C}=7~{ m mA},~{ m f}=2~{ m GHz}$	_	1.4	2.2	dB
Reverse Transfer Capacitance	$\mathrm{c}_{\mathrm{re}}$	$V_{CB} = 1 V, I_E = 0,$ f = 1 MHz (Note)	_	0.8	1.15	pF

(Note):  $C_{re}$  is measured by 3 terminal method with capacitance bridge.

#### HANDLING PRECAUTION

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

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